10/022,716

1,700-5,712				
L Number	Hits	Search Text	DB	Time stamp
1	544	press\$1coat\$3 pre\$1press\$1coat\$3	USPAT;	2004/08/31 11:32
		press\$1seal\$3 pre\$1press\$1seal\$3	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	1
			IBM TDB	ĺ
2	4351	((427/258) or (427/369) or (427/370) or	USPĀT;	2004/08/31 11:32
		(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	2004/00/31 11:32
		(427/412.2)).CCLS.	DERWENT	
3	3		USPAT;	2004/08/31 11:41
		press\$1seal\$3 pre\$1press\$1seal\$3) and		2004/08/31 11:41
		((reconstituted adj wood) "RWS" hardboard	US-PGPUB;	
		(modium adi density adi fiberbara) "MDD"	EPO; JPO;	
		(medium adj density adj fiberboard) "MDF"	DERWENT;	
		(strand adj board) (wafer adj board)	IBM_TDB	
		(flake adj board) (chip adj board)		
	0	(particle adj board))		
4	0	((Procotro protipicosticoucto	USPAT;	2004/08/31 11:34
		press\$1seal\$3 pre\$1press\$1seal\$3) and	US-PGPUB;	1
		((reconstituted adj wood) "RWS" hardboard	EPO; JPO;	:
		(medium adj density adj fiberboard) "MDF"	DERWENT;	
		(strand adj board) (wafer adj board)	IBM_TDB	
		(flake adj board) (chip adj board)	_	
}		(particle adj board))) and dispersion		
5	7753	<pre>print\$3 and ((reconstituted adj wood)</pre>	USPAT;	2004/08/31 11:42
		"RWS" hardboard (medium adj density adj	US-PGPUB;	
		fiberboard) "MDF" (strand adj board)	EPO; JPO;	
l l		(wafer adj board) (flake adj board) (chip	DERWENT;	
		adj board) (particle adj board))	IBM TDB	
6	54	(print\$3 same top\$1coat\$3) and	USPAT;	2004/08/31 11:43
		((reconstituted adj wood) "RWS" hardboard	US-PGPUB;	2001/00/31 11:43
		(medium adj density adj fiberboard) "MDF"	EPO; JPO;	
		(strand adj board) (wafer adj board)	DERWENT;	
		(flake adj board) (chip adj board)	IBM TDB	
		(particle adj board))	1511-155	
7	32	(print\$3 same top\$1coat\$3) and	USPAT	2004/08/31 11:52
	52	((reconstituted adj wood) "RWS" hardboard	USFMI	2004/08/31 11:52
		(medium adj density adj fiberboard) "MDF"		
j		(strand adj board) (wafer adj board)		
		(flake adi board) (water adj board)		
	Ì	(flake adj board) (chip adj board)		
8	۱ ۸	(particle adj board))		
O	0	(print\$3 same top\$1coat\$3 same "UV") and	USPAT	2004/08/31 11:53
		((reconstituted adj wood) "RWS" hardboard		
		(medium adj density adj fiberboard) "MDF"		İ
ļ		(strand adj board) (wafer adj board)		
		(flake adj board) (chip adj board)		
		(particle adj board))		

WPF 8/31/2004